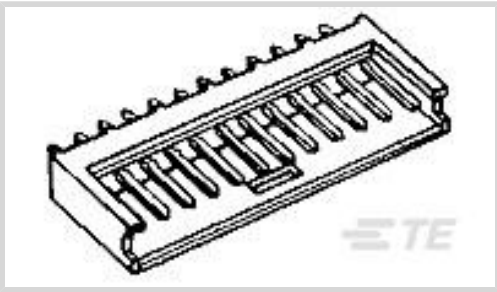




Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: **PCB Mount Header**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **4**

Number of Rows: **1**

Features

Product Type Features

|                                   |                       |
|-----------------------------------|-----------------------|
| PCB Connector Assembly Type       | PCB Mount Header      |
| Connector System                  | Board-to-Board        |
| Header Type                       | Partially Shrouded    |
| Sealable                          | No                    |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

|                                  |              |
|----------------------------------|--------------|
| Connector Contact Load Condition | Fully Loaded |
| PCB Mount Orientation            | Vertical     |
| Number of Positions              | 4            |
| Number of Rows                   | 1            |

Electrical Characteristics

|                                       |       |
|---------------------------------------|-------|
| Dielectric Withstanding Voltage (Max) | 750 V |
|---------------------------------------|-------|

Body Features

|                       |          |
|-----------------------|----------|
| Connector Profile     | Standard |
| Primary Product Color | Black    |

Contact Features

|                                                         |        |
|---------------------------------------------------------|--------|
| PCB Contact Termination Area Plating Material Thickness | 2.5 µm |
| Contact Shape & Form                                    | Round  |



|                                                |                 |
|------------------------------------------------|-----------------|
| Contact Mating Area Plating Material Finish    | Bright          |
| PCB Contact Termination Area Plating Material  | Tin             |
| Contact Base Material                          | Brass           |
| Contact Mating Area Plating Material           | Gold            |
| Contact Mating Area Plating Material Thickness | .762 μm[30 μin] |
| Contact Type                                   | Pin             |

Termination Features

|                                |                       |
|--------------------------------|-----------------------|
| Termination Post & Tail Length | 3.5 mm[.138 in]       |
| Termination Method to PCB      | Through Hole - Solder |

Mechanical Attachment

|                         |              |
|-------------------------|--------------|
| Mating Retention        | With         |
| Panel Mount Feature     | Without      |
| Mating Alignment        | With         |
| Mating Alignment Type   | Polarization |
| PCB Mount Retention     | Without      |
| PCB Mount Alignment     | Without      |
| Connector Mounting Type | Board Mount  |

Housing Features

|                    |                |
|--------------------|----------------|
| Centerline (Pitch) | 2.54 mm[.1 in] |
| Housing Material   | Thermoplastic  |

Dimensions

|                    |                |
|--------------------|----------------|
| Row-to-Row Spacing | 2.54 mm[.1 in] |
|--------------------|----------------|

Usage Conditions

|                             |                            |
|-----------------------------|----------------------------|
| Housing Temperature Rating  | Standard                   |
| Operating Temperature Range | -65 – 105 °C[-85 – 221 °F] |

Operation/Application

|                     |                |
|---------------------|----------------|
| Circuit Application | Power & Signal |
|---------------------|----------------|

Packaging Features

|                    |      |
|--------------------|------|
| Packaging Quantity | 1000 |
| Packaging Method   | Box  |

Product Compliance



For compliance documentation, visit the product page on TE.com>

|                                               |                                                                                                                                 |
|-----------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------|
| EU RoHS Directive 2011/65/EU                  | Compliant                                                                                                                       |
| EU ELV Directive 2000/53/EC                   | Compliant                                                                                                                       |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold                                                                                         |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JUNE 2024 (241)<br>Candidate List Declared Against: JUNE 2024 (241)<br>Does not contain REACH SVHC |
| Halogen Content                               | Not Low Halogen - contains Br or Cl > 900 ppm.                                                                                  |
| Solder Process Capability                     | Wave solder capable to 265°C                                                                                                    |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Also in the Series | AMPMODU Headers





Connector Caps & Covers(1)

Connector Contacts(64)

Connector Hardware(2)

PCB Headers & Receptacles(3202)

Wire-to-Board Connector Assemblies & Housings(5)

Customers Also Bought

TE Part #6-1415027-1  
SR6D4024

TE Part #8-215464-0  
10P.MICRO-MATCH MOB

TE Part #280509-2  
2X09 POS .100DR MODU-

TE Part #8-1415536-6  
0410 83 046 001WG

TE Part #1734303-1  
SHIELD FINGER 4025B-T

TE Part #7-1676481-5  
CPF 0603 8K2 0.1% 25PPM 1K RL

TE Part #2-1823504-1  
124POS, MIXED,HEADER ASSY

TE Part #7-6437144-0  
FSN-23A-6

TE Part #350639-1  
MNL PIN PTPBR

TE Part #384462-E  
SRCP 2,54 4 M 1 SMD 137 E1 094 \* GU-H \*

Documents



Product Drawings

4P AMPMODU II SHRD HDR, ST, 0.76AU

English

CAD Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_280371-3\_U\_c-280371-3-u.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_280371-3\_U\_c-280371-3-u.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_280371-3\_U\_c-280371-3-u.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.